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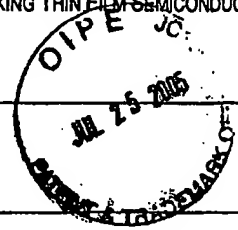
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Docket No.: 09792909-3402
 Client: SONY CORPORATION
 1st Inventor: TAYANAKA, Hiroshi
 Title of Invention: THIN FILM SEMICONDUCTOR AND METHOD FOR MAKING THIN FILM SEMICONDUCTOR
 U.S. Patent No: 6,326,280
 Filed Date: Herewith

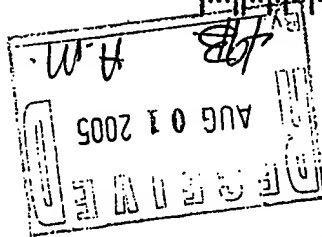
1. Disclaimer in Patent Under 37 CFR 1.321(a) (1 page);
2. Credit Card Payment Form (1 pg); and,
2. Post card receipt (1).



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